

<u>Patent</u>

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

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In re Application of: DEPPISCH et al.	Examiner: Not yet assigned	
Serial No.: Not yet assigned	Group Art Unit: Not yet assigned	
Filing Date: Filed herewith	INTEL Docket No.: P17175	
For: INTEGRATED SOLDER AND HEAT SPREADER FABRICATION)		

MS PATENT APPLICATION

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

UTILITY PATENT APPLICATION TRANSMITTAL (Large Entity)

Sir:

Transmitted herewith for filing under 35 USC 111(a) and 37 CFR 1.53(b) is a new utility patent application for an invention entitled: INTEGRATED SOLDER AND HEAT SPREADER FABRICATION

and invented by: DEPPISCH et al.

Enclosed are:

- 1. ☑ Filing Fee as calculated and transmitted as described below
- 2. Specification having 14 pages and including the following:
 - a. Descriptive Title of the Invention
 - b.

 Cross references to Related Applications (if applicable)

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		c.	c. Statement Regarding Federally-sponsored Research/Development					
		d.		Reference to 1	Microfiche Appendix (if applica	ble)		
		e.	$\overline{\mathbf{A}}$	Background o	f the Invention			
		f.	Brief Summary of the Invention					
		g.	g.					
		h.		☑ Detailed Description				
		i.	$\overline{\mathbf{A}}$	Claim(s) as C	lassified Below			
		j.		Abstract of the	e Disclosure			
3.		Dr	Drawing(s) (when necessary as prescribed by 35 USC 113)					
		a.		Formal	Number of Sheets 14			
		b.		Informal	Number of Sheets			
4.	☑	Oa	th o	r Declaration				
		a.	☑	Newly execut	ed (original or copy)	☐ Unexecuted		
		b.		Copy from a p	prior application (37 CFR 1.63	(d))		
		c.	\square	With Power o	f Attorney	☐ Without Power of Attorney		
		d.		Signed statem	OF INVENTOR(S) ent attached deleting inventor(0.63(d)(2) and 1.33(b).	(s) named in the Prior Application,		
5.		Incorporation By Reference (usable if Box 4b is checked) The entire disclosure of the prior application, from which a copy of the oath or declaration is supplied under Box 4b, is considered as being part of the disclosure of the accompanying application and is hereby incorporated by reference therein.						
6.		As	sign	ment Papers (a	cover sheet & documents(s))			
7.		37 CFR 3.73(B) Statement (when there is an assignee)						
8.		English Translation Document (if applicable)						
9.		Information Disclosure Statement/PTO-1449 Copies of IDS Citations						
10.		Preliminary Amendment						
11.		Acknowledgement Postcard						
12.	Ø	Ma	ailed	l Via				
			Firs	t Class	☑ Express Mail (Specify Laber	l No.) EL963891515US		
13.		Ce	Certified Copy of Priority Document(s) (if foreign priority is claimed)					
14.		Request and Certification under 35 USC 122(b)(2)(B)(i) (attach PTO/SB/35)						
15	M	Additional Enclosures: Credit Card Payment Form						

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FEE CALCULATION

For	No. Filed	No. Allowed	No. Extra	Rate	Fee
Total Claims	23	- 20	3	\$ 18.00	\$ 54.00
Indep. Claims	5	- 3	2	\$ 86.00	\$ 172.00
Multiple Depend	\$ 0.00				
	\$ 770.00				
OTHER FEE (\$ 0.00			
	\$996.00				

Credit Card Authorizations for \$ 996.00 and \$40.00 are enclosed.

The Commissioner is hereby authorized to charge and credit Deposit Account No. <u>50-1852</u> as described below. A duplicate copy of this sheet is enclosed.

☑ Credit any overpayment.

☑ Charge any additional fees required under 37 CFR 1.16 and 1.17.

Respectfully submitted,

<u>December 5, 2003</u>

Date

Nandu A. Talwalkar

Registration No. 41,339

Attorney for Intel Corporation

Buckley, Maschoff & Talwalkar LLC

Five Elm Street

New Canaan, CT 06840

(203) 972-0049